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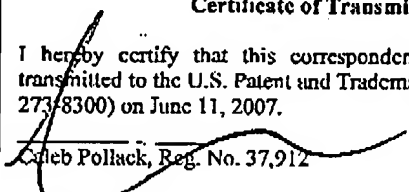
Attorney Docket No.: P-6121-US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): TAY, Cheng Siew, et al. Examiner: NORRIS, Jeremy C.
Serial No.: 10/735,638 Group Art Unit: 2841
Filed: December 16, 2003
Title: Printed Circuit Boards Having Pads For Solder Balls And Methods For The
Implementation Thereof

AMENDMENT

5 Pages Via Facsimile: 571-273-8300
Box Non-Fee Amendment
Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

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I hereby certify that this correspondence is being facsimile transmitted to the U.S. Patent and Trademark Office (fax no. 571-273-8300) on June 11, 2007.
 Caleb Pollack, Reg. No. 37,912

Sir:

This Amendment is being filed in response to the Office Action mailed on March 20, 2007. A response is due June 20, 2007. Accordingly, this Amendment is being timely filed. Please amend the application as follows:

The Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 4 of this paper.